

ABSTRACT

The invention provides a resin composition for cleaning a die, the resin composition including; a melamine-based resin; a first curing catalyst having a melting temperature of from 43°C to 115°C; and a second curing catalyst having a melting temperature that is from 53°C to 125°C and that is higher by 10°C or more, than the melting temperature of the first curing catalyst.